

RA2E1 Group

Sensor & Touchless key demo evaluation tool “Sensor & Touchless key Monitor”

Introduction

This application note explains how to use RA2E1 Group Sensor & Touchless key demo evaluation tool “Sensor & Touchless key Monitor”.

Target Device

Windows®10

Related Documents

- (1) RA2E1 Group Sensor & Touchless key Demo Board (R12AN0013EJ0100)
- (2) RA2E1 Group Sensor & Touchless key Demo Sample software (R11AN0492EJJ0100)
- (3) Overview of TVOC and Indoor Air Quality

Contents

1. Outline.....	3
1.1 Configuration	3
2. Instruction.....	4
2.1 Start Sensor & Touchless key Monitor.....	4
2.2 Connect to RA2E1 Group Sensor & Touchless key Demo board.....	4
3. Screen.....	6
3.1 Display of mode.....	6
3.2 Button detection display	8
3.3 Temperature display	8
3.4 Humidity display	8
3.5 Temperature mapping display	9
3.6 Indoor Air Quality (IAQ) display	10
4. Operation mode.....	11
Revision History.....	13

1. Outline

Sensor & Touchless key Monitor is an application that assumes the use for rangehood control. Connect RA2E1 Sensor & Touchless key Demo board to COM port to check and confirm the operation mode and environment sensor (temperature/humid and gas), capacitive touch sensor and thermopile operation assuming the range hood operation in real time.

This application supports following functions.

- Display Indoor Air Quality (IAQ) by gas sensor (ZMOD4410)
- Display Temperature / Humidity measured by Temperature and Relative humidity sensor (HS3001)
- Display Capacitive touch electrode measurements
- Display temp-mapping by Thermopile
- Demonstration assuming range hood operation

1.1 Configuration

- PC (Windows®10) *does not work on (Windows®7/8/8.1)
- RA2E1 Group Sensor & Touchless key demo board
- Sensor & Touchless key demo evaluation tool (Monitor. exe)* *No need to install
- Micro USB cable

Figure 1.1 shows demo evaluation environment.

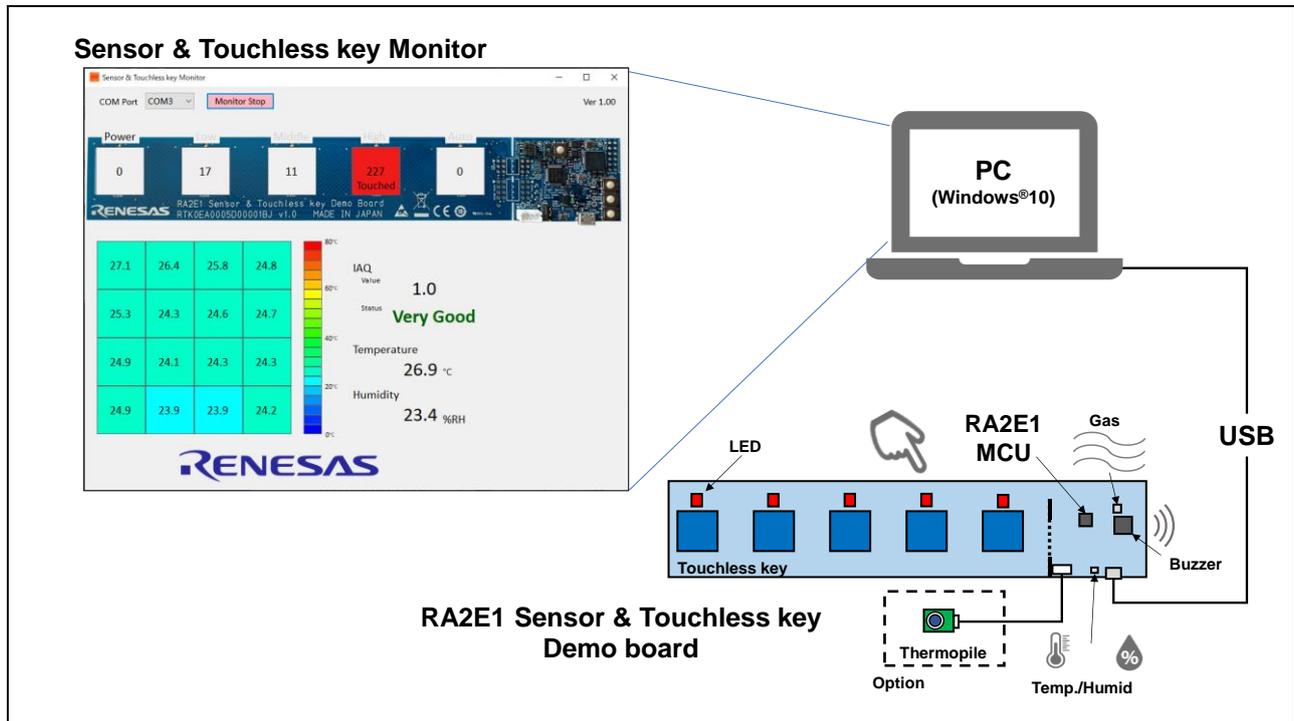


Figure 1. Demo evaluation environment

2. Instruction

2.1 Start Sensor & Touchless key Monitor

Start “Monito.exe” and following appears on PC screen.

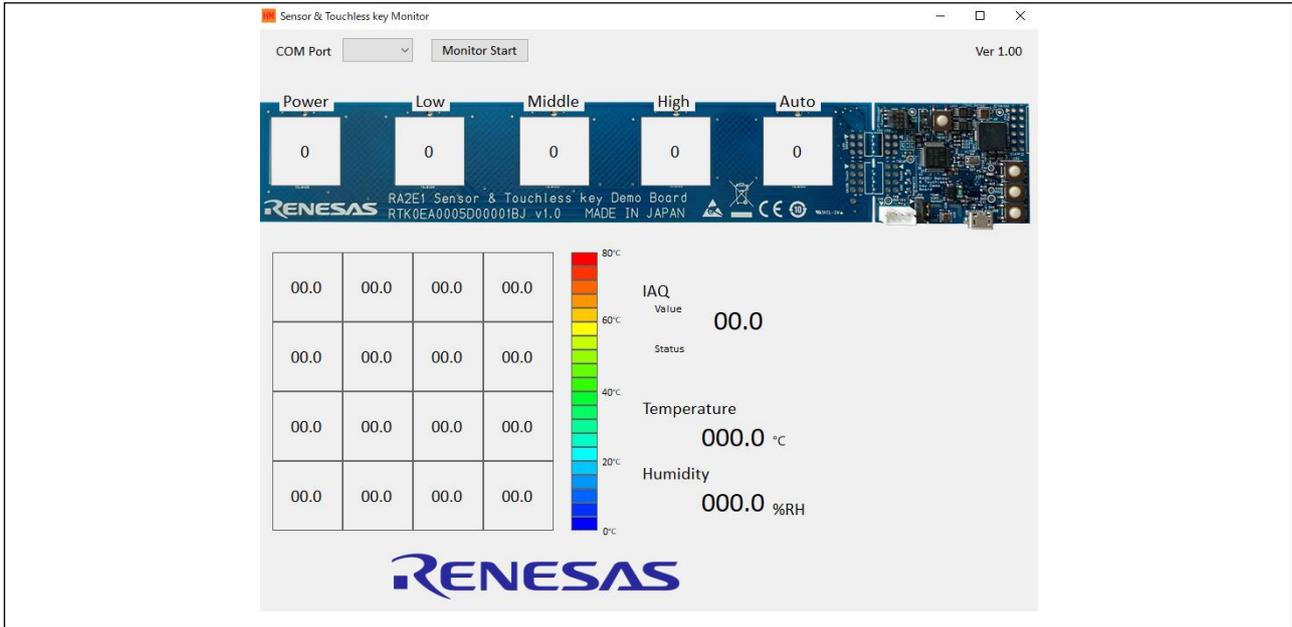


Figure 2.1 Start screen

2.2 Connect to RA2E1 Group Sensor & Touchless key Demo board

1. Connect Demo board to PC.
2. Set COM Port. If there are several COM Port, confirm device manager to select the COM port number from USB Serial Port (COMx).
3. Press “Monitor Start”.

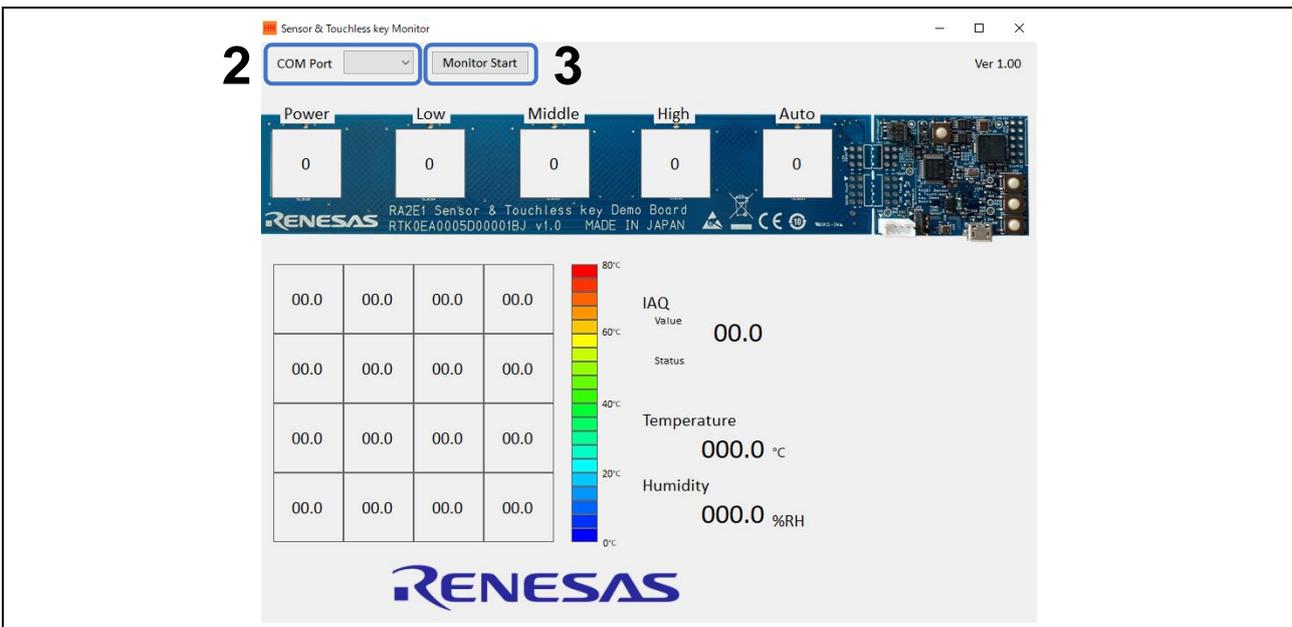


Figure 2.2 Connect to Demo board

After pressing “Monitor Start”, it will show measurements of each sensor and capacitive touch electrode.

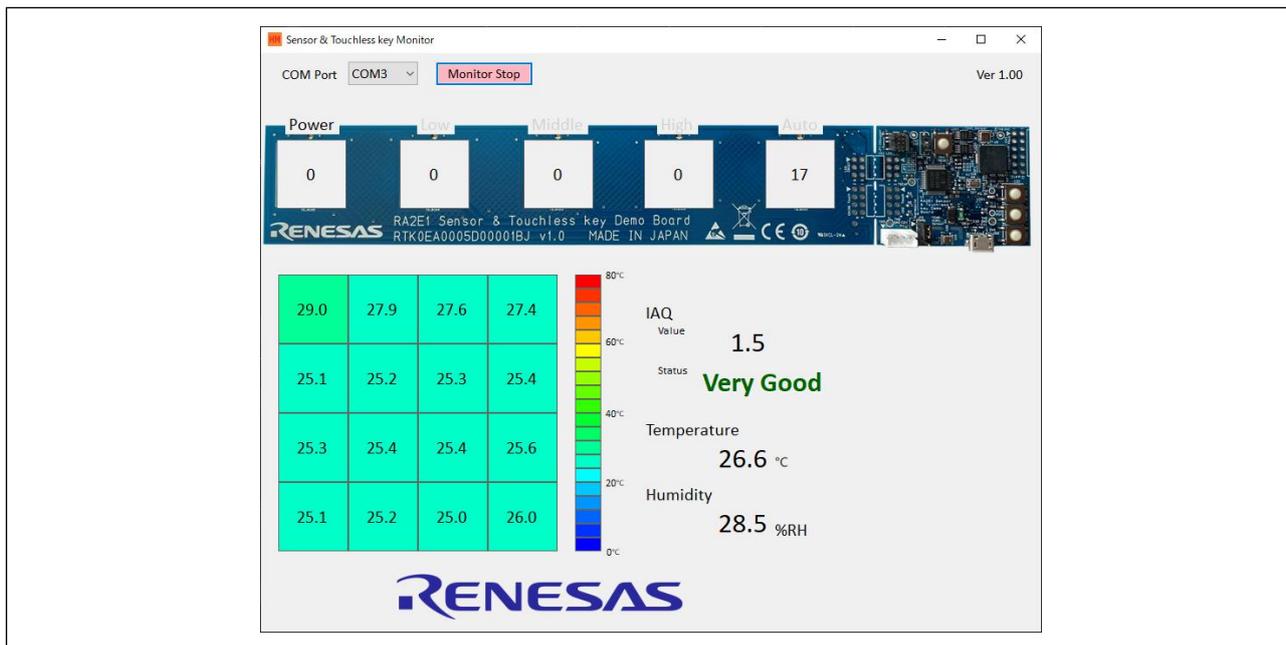


Figure 2.3 Demonstration screen

Refer chapter 3 and 4 for the detailed display and operation of the demo.

3. Screen

3.1 Display of mode

Change the back ground color of mode name to orange depending on the operation mode.

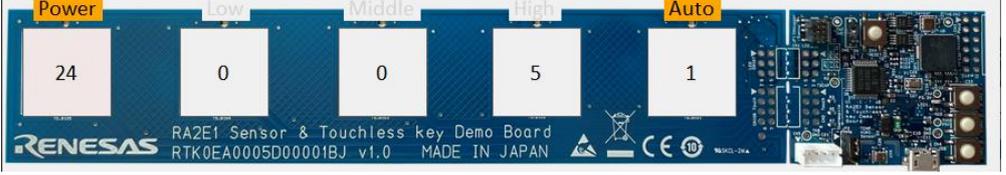
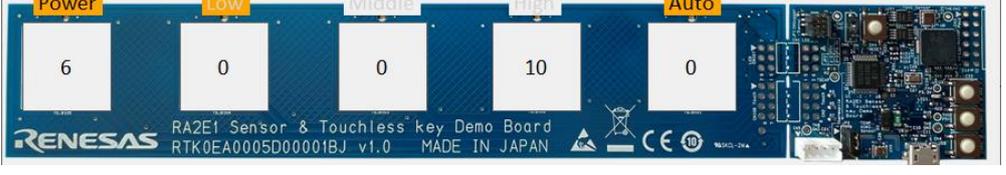
Refer detail of each mode for chapter 4. Operation Modes.

Table 3.1 and table 3.2 shows the display of each mode.

Table 3.1 Display of Modes (Normal mode)

Mode name	Display
Normal mode (Off mode)	
Normal mode (Low mode)	
Normal mode (Middle mode)	
Normal mode (High mode)	

Table 3.2 Display of Modes (Auto mode)

Mode name	Display
Auto mode0 (Stop)	 <p>RENEASAS RA2E1 Sensor & Touchless key Demo Board RTK0EA0005D00001BJ v1.0 MADE IN JAPAN</p>
Auto mode1 (Low mode)	 <p>RENEASAS RA2E1 Sensor & Touchless key Demo Board RTK0EA0005D00001BJ v1.0 MADE IN JAPAN</p>
Auto mode2 (Middle mode)	 <p>RENEASAS RA2E1 Sensor & Touchless key Demo Board RTK0EA0005D00001BJ v1.0 MADE IN JAPAN</p>
Auto mode3 (High mode)	 <p>RENEASAS RA2E1 Sensor & Touchless key Demo Board RTK0EA0005D00001BJ v1.0 MADE IN JAPAN</p>
Auto mode4 (Alert)	 <p>RENEASAS RA2E1 Sensor & Touchless key Demo Board RTK0EA0005D00001BJ v1.0 MADE IN JAPAN</p> <p>LED(Auto) turns ON/OFF and buzzer alert comes off and buzzer stopes when AUTO button detected.</p>

3.2 Button detection display

When the capacitive touch electrode value is over the threshold (150), it is judged as touched and displays "Touched".

The color of button on the monitor changes as the distance between finger and electrode. Closer the finger to the electrode, darker the color becomes and larger the value turns.

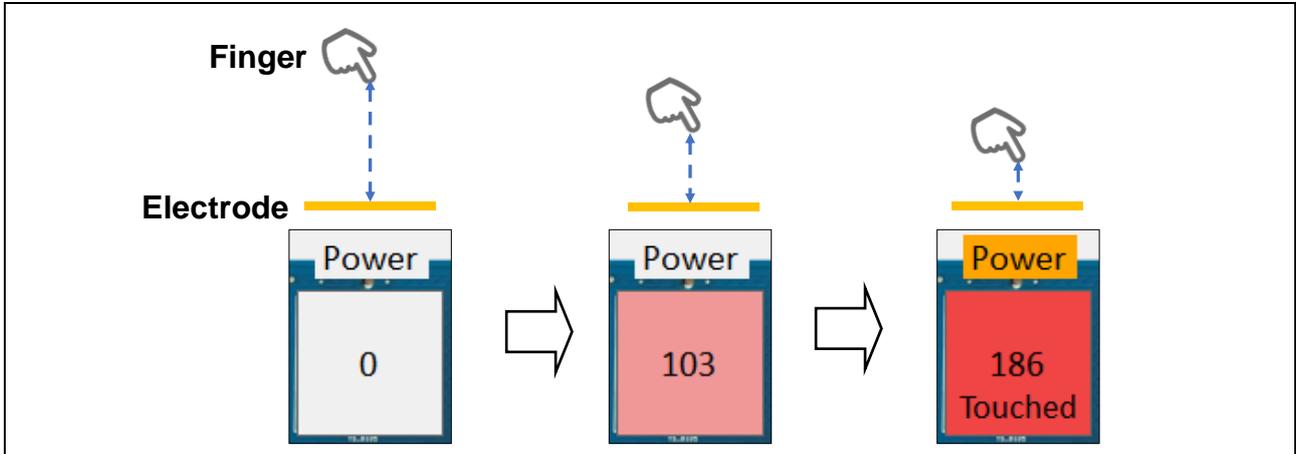


Figure 3.1 Button detection display

3.3 Temperature display

It displays temperature measured by Temperature and Relative Humidity sensor (HS3001).

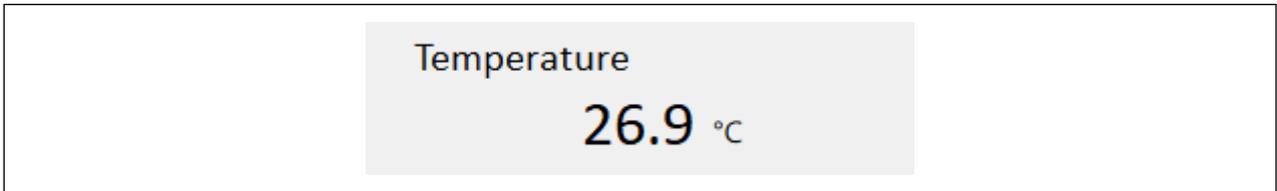


Figure 3.2 Temperature display

3.4 Humidity display

It displays relative humidity measured by Temperature and Relative Humidity sensor (HS3001).

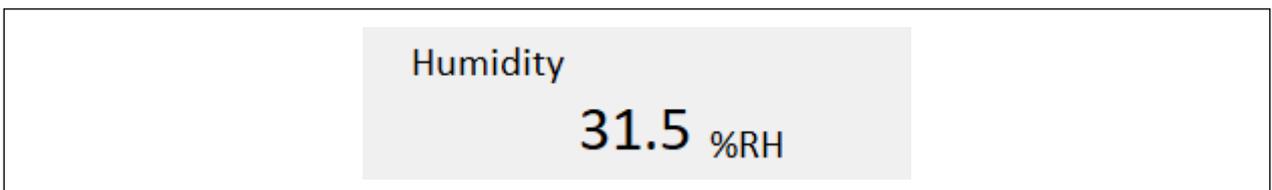


Figure 3.3 Humidity display

3.5 Temperature mapping display

Displays temperature mapping measured by thermopile in 16 elements.

Color changes depending on the temperature.

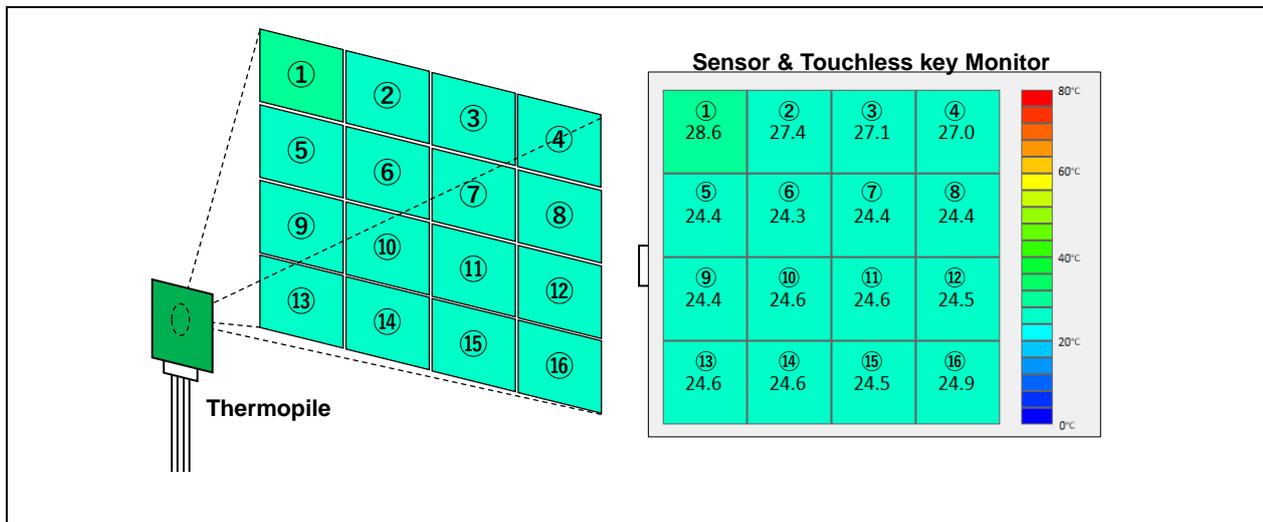


Figure 3.4 Temperature mapping

3.6 Indoor Air Quality (IAQ) display

It displays IAQ data measured by Gas sensor (ZMOD4410).

- IAQ Value
Displays IAQ value.
Value stays 0 after start for 3 minutes, during sensor warming up.
- IAQ Status
Shows air quality status correspond to IAQ rating.
Figure3.6 shows IAQ status correspond to IAQ Rating.
Refer “IAQ Classification” in related document (3) Overview of TVOC and Indoor Air Quality for the criteria of Status.

Overview of TVOC and Indoor Air Quality

<https://www.renesas.com/us/en/document/whp/overview-tvoc-and-indoor-air-quality?language=en>

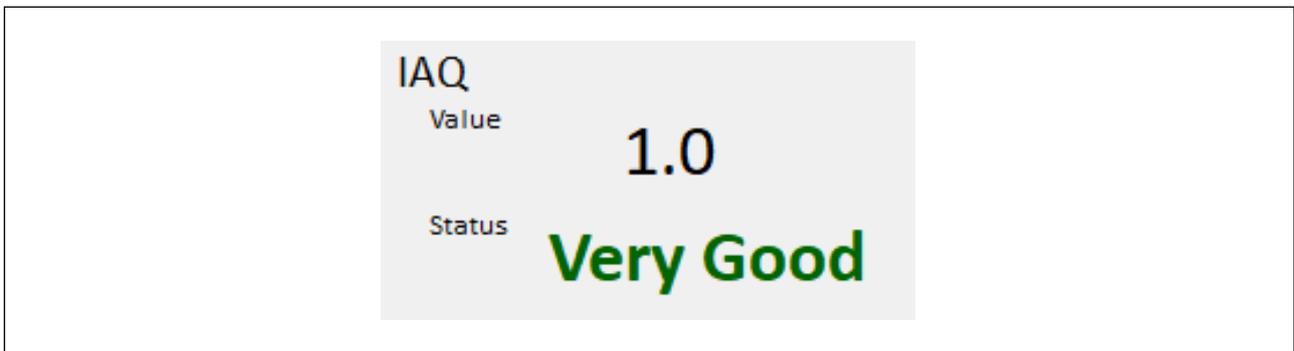


Figure 3.5 Indoor Air Quality (IAQ) display

IDT IAQ Rating	Air Quality
≤ 1.99	Very Good
2.00 to 2.99	Good
3.00 to 3.99	Medium
4.00 to 4.99	Poor
≥ 5.00	Bad

Figure 3.6 IAQ Classification

4. Operation mode

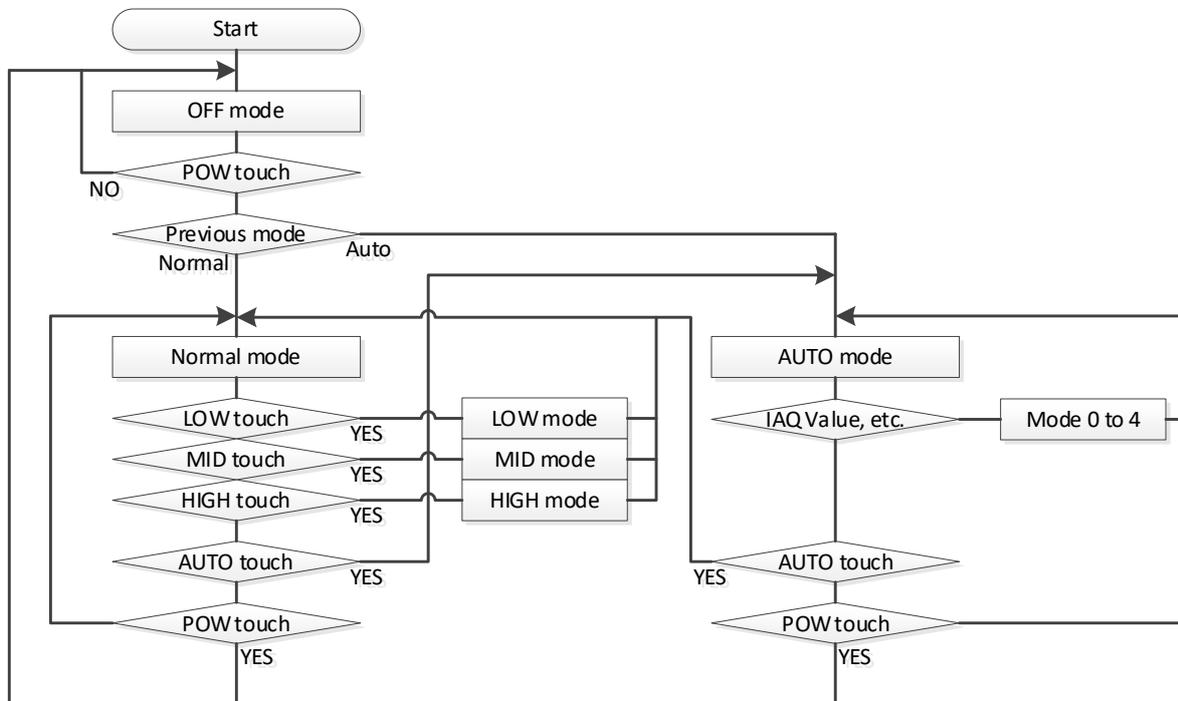
There are normal mode and AUTO mode for operation.

In normal mode, key operation is done manually.

In AUTO mode, it automatically switches operation mode by IAQ and Thermopile value (number of data over 40°C).

- Normal mode
 - Off mode
 - Low mode
 - Middle mode
 - High mode

The transaction of modes is as following.



- AUTO mode

In AUTO mode, operation follows IAQ value and Thermopile value (number of data over 40°C).

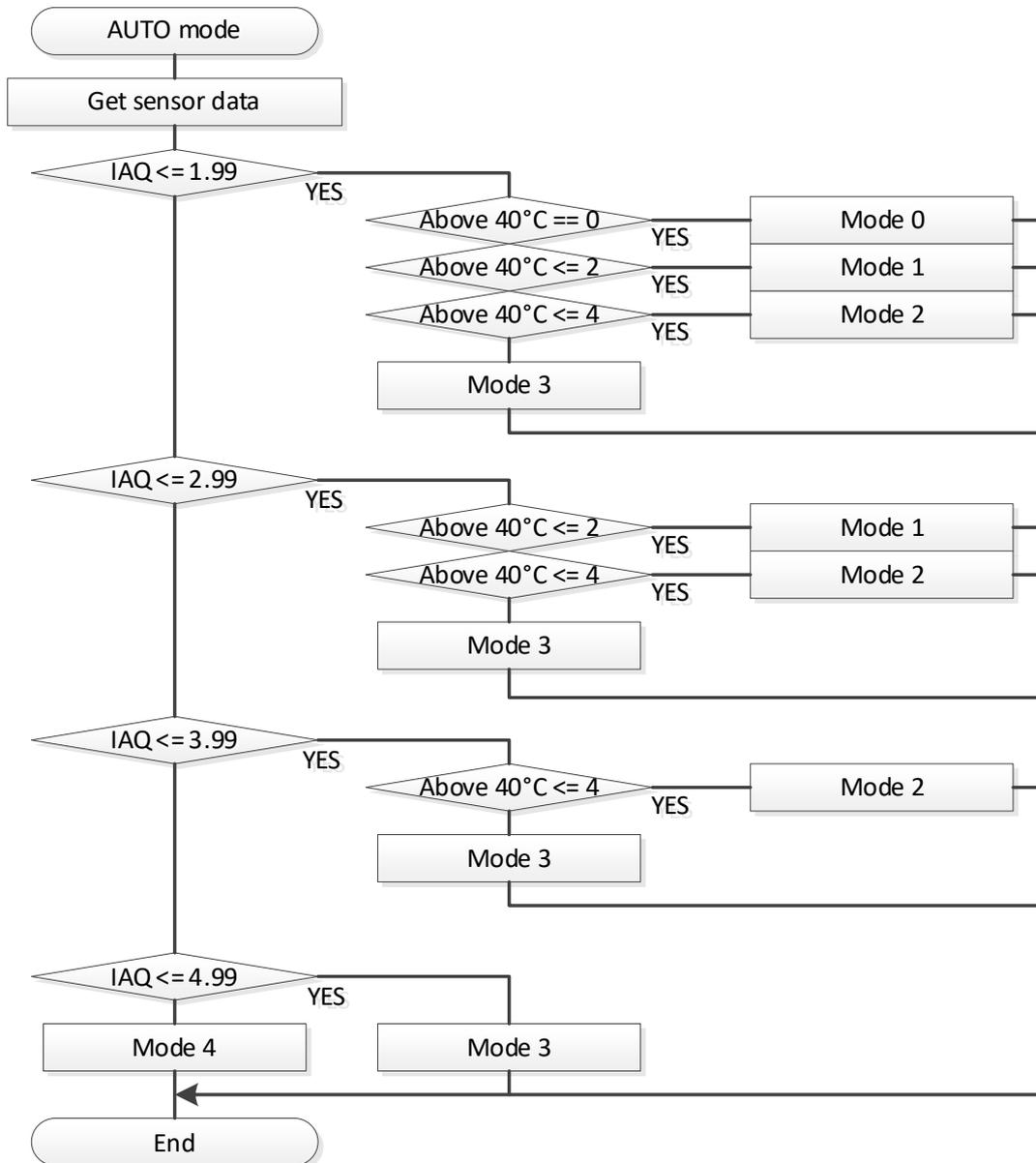
Mode 0 : Stop

Mode 1 : Low mode

Mode 2 : Middle mode

Mode 3 : High mode

Mode 4 : Alert



Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Feb.11.21	-	First release

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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(Rev.5.0-1 October 2020)

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